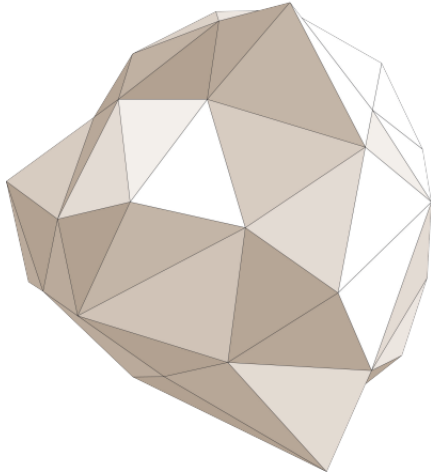


Comsol Multiphysics Simulation Integrated into Genetic Optimization

INNOVATION MAKERS



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OUTLINE

- Context & Objectives
- Thermoelectric Micro-Generators
- Genetic Algorithm
- Optimization Tool
- Results
- Conclusion

CONTEXT

industrial research program focused on the development of thermoelectric micro-generators (μ TEGs) based on innovative materials

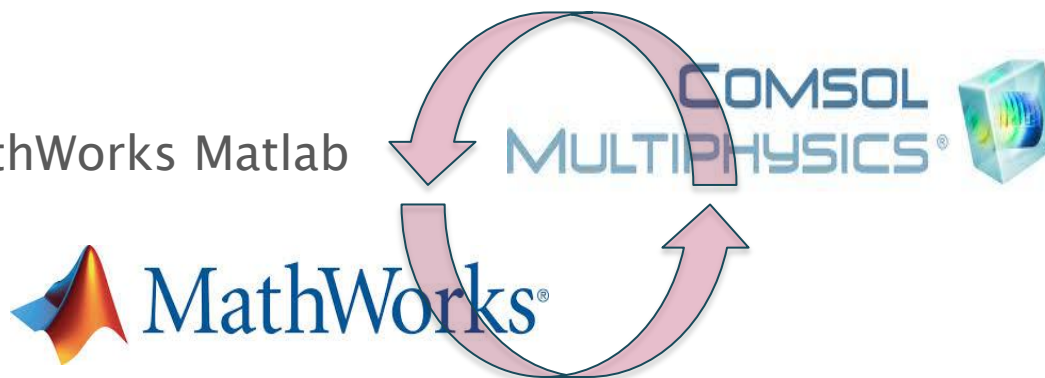
GOAL

innovative tool of modeling, simulation and optimization

- ✓ **system performances improvement**
- ✓ **huge numbers of parameters and constraints**
- ✓ **wide range of applicability**

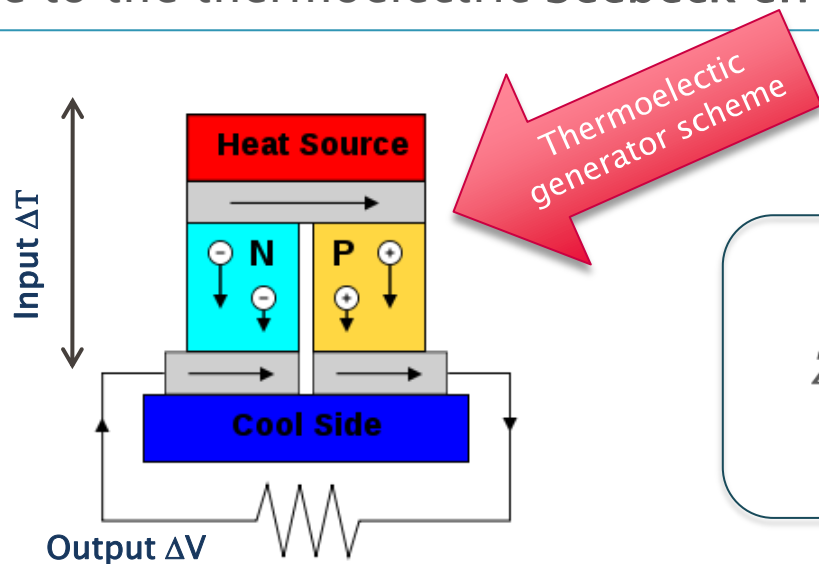
APPROACH

interaction between
Comsol Multiphysics and MathWorks Matlab



DEFINITION

A thermoelectric micro-generator (μ TEG) is a solid state device able to generate an electric potential when it is exposed to a temperature gradient due to the thermoelectric **Seebeck effect**

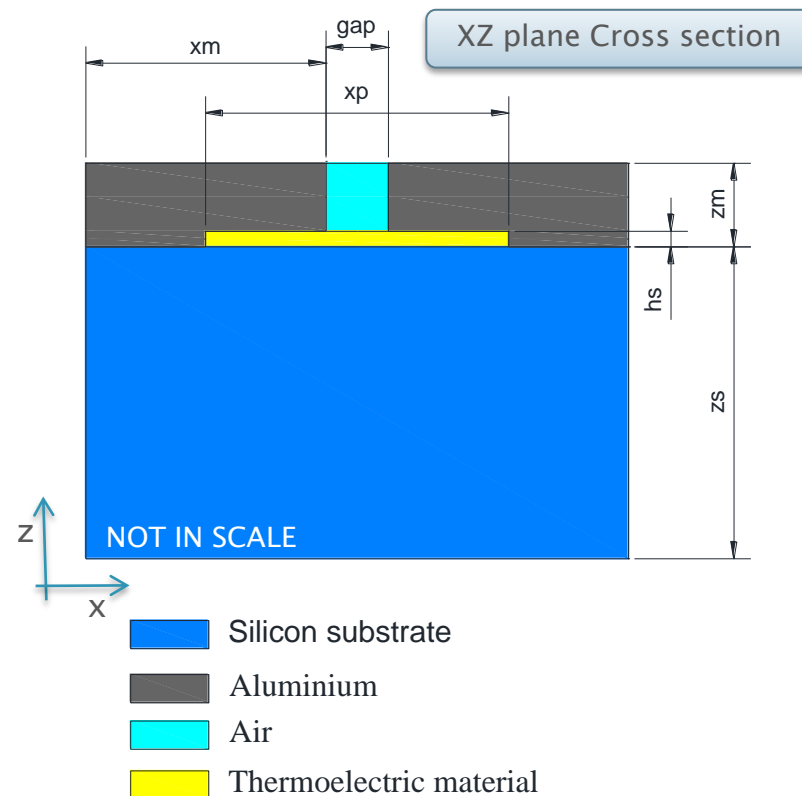
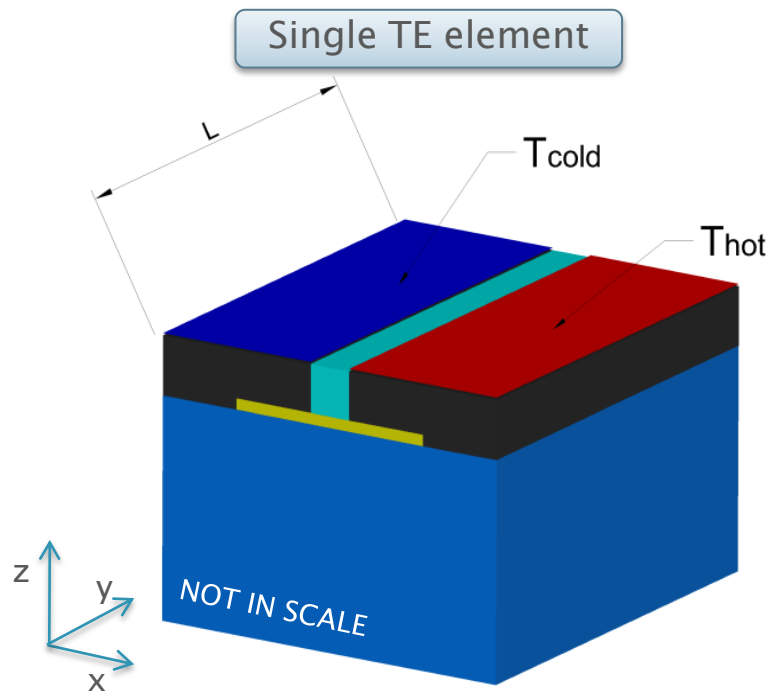


THERMOELECTRIC FIGURE OF MERIT

$$ZT = \frac{\alpha^2 \sigma}{k} T$$

α : Seebeck coefficient
 σ : Electric conductivity
 k : Thermal conductivity
 T : Absolute temperature

The possibility of using μ TEGs to convert waste heat into electricity has recently regained interest as a consequence of the discovery of high ZT values in a certain range of materials, but in order to fabricate an **high efficiency μ TEG**, it is necessary to design the **optimal geometry** of the μ TEG's element!



Heat exchange surfaces:

$T_{\text{hot side}} = 493.15\text{K}$

$T_{\text{cold side}} = 293.15\text{K}$

Electric exchange surfaces:

Cold side: Potential ground

Hot side: Variable potential

Variable	PROJECT VALUE
xm	$55 \mu\text{m}$
xp	$7 \mu\text{m}$
gap	$4 \mu\text{m}$
zm	$6 \mu\text{m}$

The main physical quantities are

- heat flux (Q)

- electric current flux (J)



$$\begin{cases} Q = \alpha T J - k \nabla T \\ J = \sigma E - \sigma \alpha \nabla T \end{cases}$$

Governing equation for thermoelectric effect are:

- Heat energy conservation

- Electric current balance

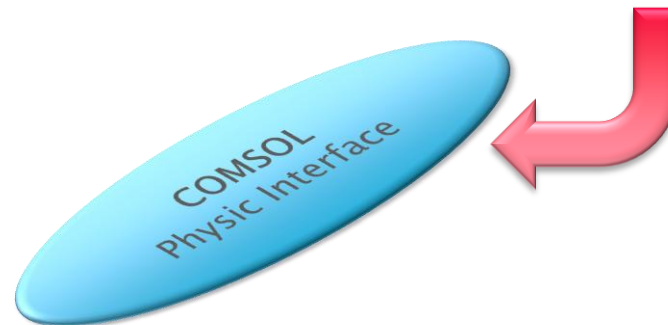
$$\nabla \cdot Q = J \cdot E$$

$$\nabla \cdot J = 0$$

Stationary case

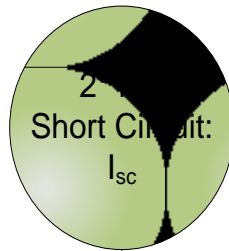
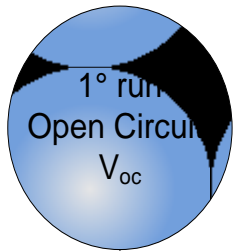
$$\nabla \cdot [\alpha T (-\sigma \nabla V - \sigma \alpha \nabla T) - k \nabla T] = (-\sigma \nabla V - \sigma \alpha \nabla T) \cdot (-\nabla V)$$

$$\nabla \cdot (-\sigma \nabla V - \sigma \alpha \nabla T) = 0$$



The single TE element can be schematized with an equivalent electric circuit.

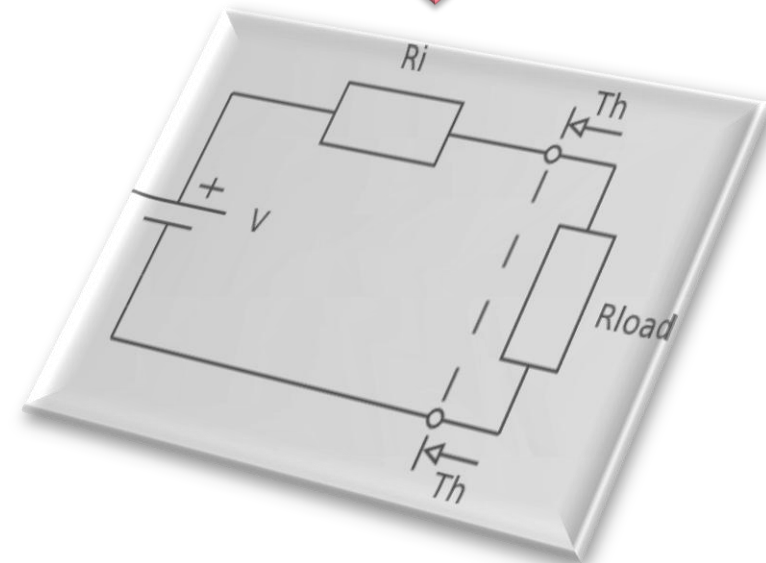
Calculation method



Post processing electric power evaluation

$$P_{load} = \frac{V^2}{4R_i^2} = \frac{V_{oc}I_{sc}}{4}$$

Max power transfert



V: Seebeck generated voltage
 R_i : Internal resistance of the TE generator
 R_{load} : Load resistance

OPTIMIZATION PROBLEM FORMULATION

$\max f(x)$ *objective function*

such that:

$$c(x) \leq 0$$

non-linear constraints

$$A \cdot x \leq b$$

linear constraints

$$l \leq x \leq u$$

lower and upper bounds

FIRST CHOICE  OBJECTIVE FUNCTION

Electric Power Density = Electric Power/Area
(Watt/cm²)

In manufacturing processes

✓ *maximize the electrical power*

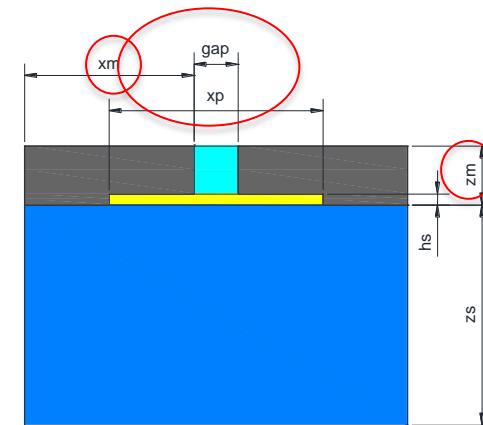
✓ *minimize the area in order to reduce the probability of defect occurrence at wafer level*





SECOND CHOICE VARIABLES TO OPTIMIZE

Upper & Lower Bound Definition

VARIABLES TO OPTIMIZE		
NAME	LOWER BOUND	UPPER BOUND
x_m	10 μm	60 μm
x_p	6 μm	10 μm
gap	4 μm	5 μm
z_m	1 μm	6 μm

Given by specialists



-  Silicon substrate
-  Aluminium
-  Air
-  Thermoelectric material

THIRD CHOICE CONSTRAINTS DEFINITION

Linear Constraint

$$x_p - \text{gap} > 2\mu\text{m}$$

Technical constraint: lithography resolution

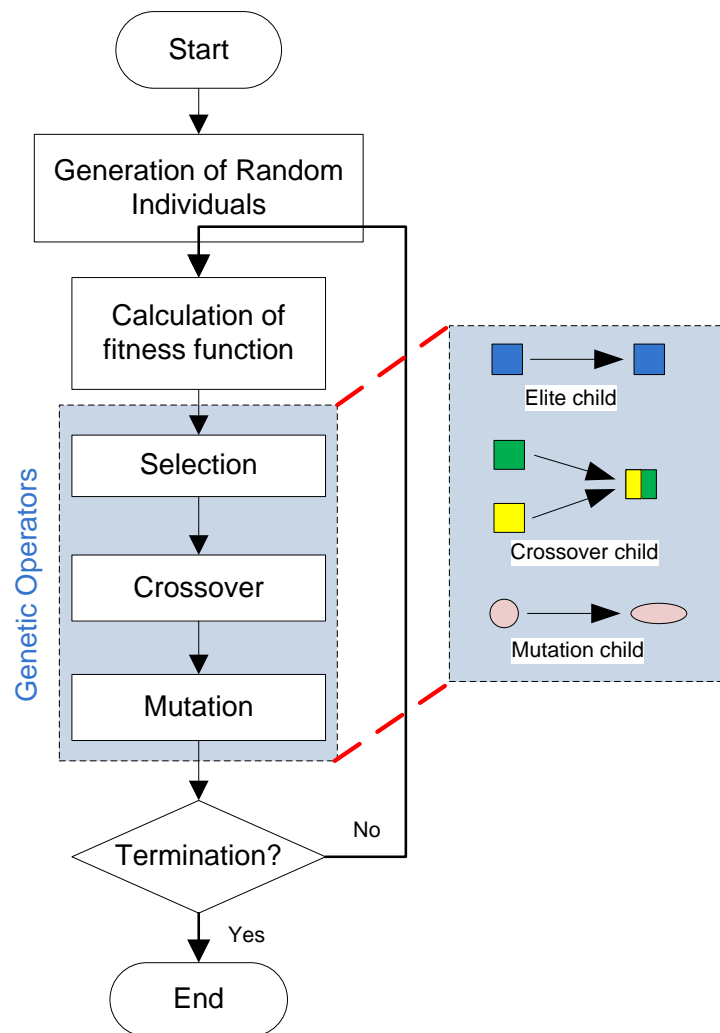
GENETIC ALGORITHM: heuristic search that simulates the process of natural selection

The algorithm starts by creating a random initial feasible population; then it creates a sequence of new populations.

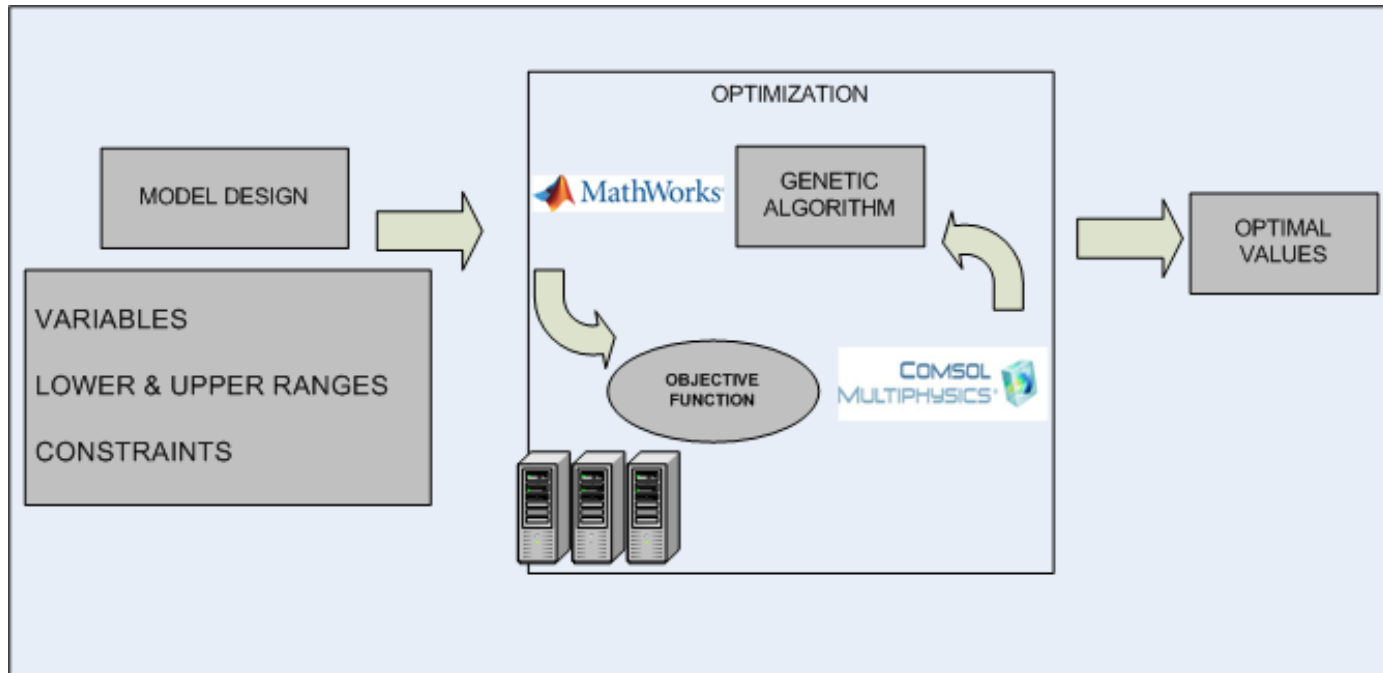
At each step:

- It **scores** each individual of the current population by computing its **fitness value**
- It **selects** members, called **parents**, based on their fitness, in order to create the next population.
- It creates the new population from parents by means of **selection**, **crossover** and **mutation**

It stops when **stopping criteria** is met: average cumulative change over generations




- Genetic Algorithm is implemented in MathWorks MatLab
- Electrical Power Density is the fitness function and its evaluation is performed by Comsol Multiphysics



At each generation, for each individual processed by genetic algorithm, MatLab sets new values into Comsol model's parameters and invokes Comsol simulations to evaluate fitness function

Genetic Algorithm finds **optimal values** for each variable:

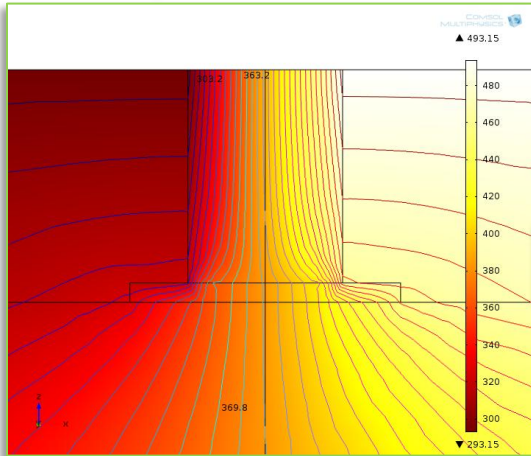
Variable	PROJECT VALUE	OPTIMIZED VALUE
xm	55 μm	10 μm
xp	7 μm	7.36 μm
gap	4 μm	4 μm
zm	6 μm	2.12 μm



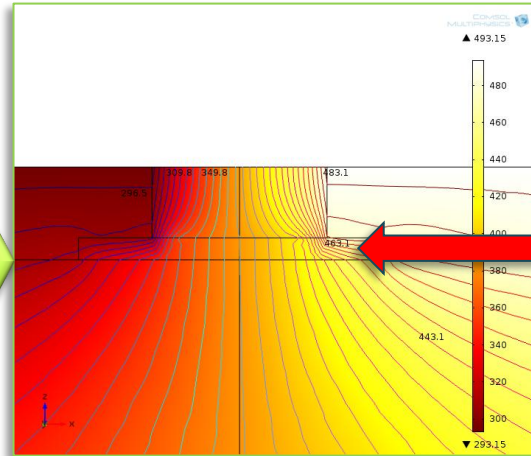
Optimal values **maximize** electrical power density :

FEATURE	PROJECT VALUE	OPTIMIZED VALUE
Horizontal area (S)	2280 μm^2	480 μm^2
Electric Potential (V)	57.80 mV	69.92 mV
Electrical Current (I)	5.75 mA	7.10 mA
Heat flux	435.18 mW	274.33 mW
Electric Power generated (Pload)	0.08 mW	0.12 mW
Electric Power Density (Pd)	3.64 W/cm ²	25.86 W/cm ²

Heat map

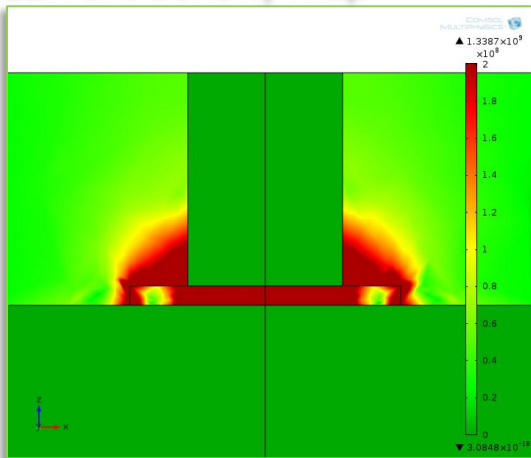


Optimization

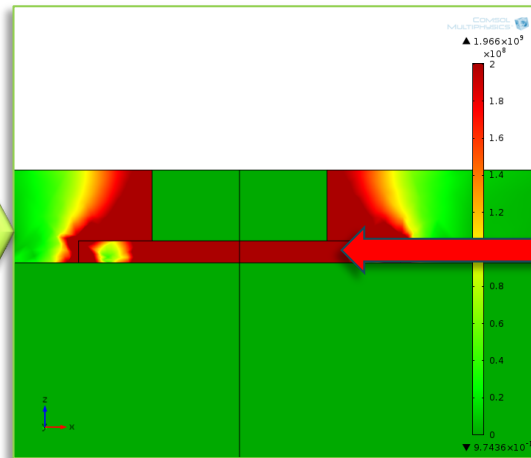


Thermal gradient on the active material

Current density map



Optimization



Electric current density distribution

- This work aims at demonstrating the **power of interaction** of multi-physics simulation with the optimization approach of genetic algorithms
- Numerical **results** must be considered **demonstrative**
- The tool **greatly improves** μ TEG's performances
- More generally, this tool can be a precious contribution to device designers, especially when device models have many variables to take in account and many complex geometrical or technical constraints.

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